Winstac Display (Shenzhen) Limited.

威世达显示器科技(深圳)有限公司

SPECIFICATION FOR LCD MODULE

MODULE NO.: LCM-TGG000177YP02-01

Customer Approval:	

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
CHECKED BY		
APPROVED BY		

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1. Features & Mechanical Specifications

Item	Contents	Unit
LCD Type	TFT , Negative , Transmissive	_
Viewing direction	12 o'clock	_
Backlight	White LED Backlight	_
Interface	8080 MCU 8-bit parallel interface	_
Driver IC	ST7732	
Outline Dimension	34(W) ×45.78(H) ×3.75(MAX)(T)	mm
Viewing area (W×H)	30.03×40.1	mm
Active area (W×H)	28.03 x 35.04	mm
Number of Dots	128(RGB) x 160	1
Pixel pitch (W×H)	0.219 x 0.219	mm
Operating Temperature	-20 ~ +7 0	$^{\circ}$
Storage temperature	-30 ~ +80	$^{\circ}$

2. Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	_	-0.3	+4.6	V
Input voltage	Vin		-0.3	VDD+0.3	V
Operating Temperature	TOP	_	-20	+70	$^{\circ}$
Storage Temperature	TST	_	-30	+80	$^{\circ}$
Storage Humidity	HD	Ta<40℃	20	90	%RH

Note: If the module is used above these absolute maximum ratings, it may become permanently damaged. Using the module within the above electrical characteristic limit is strongly recommended for normal operation.

3. DC Electrical Characteristics

GND=0V, Ta=25°C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VDD	_	2.5	2.8	3.3	>
Input High Voltage	VIH	_	0.7VDD		VDD	V
Input Low Voltage	VIL	_	GND	1	0.3VDD	٧
Output High Voltage	VOH	_	0.8VDD	1	VDD	V
Output Low Voltage	VOL	_	GND		0.2VDD	V
Supply Current	ICC	VDD=2. 8V	_	10	15	mΑ

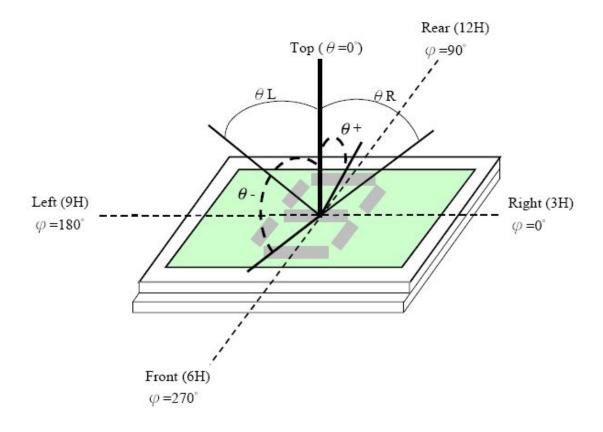
4. Backlight Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=15*2mA	3.0	3.2	3.4	V
Reverse Current	IR	Vr=5V	_	1	80	μΑ
Average	IV	IF=15*2mA	1500	_		cd/m²
Brightness	IV	IF=15 ZIIIA	1500			Cu/III
CIE Color	X	IE 45*2m A	0.265	1	0.305	_
Coordinate	Υ	IF=15*2mA	0.265		0.305	_
Color			White			

5. Electro-Optical Characteristics

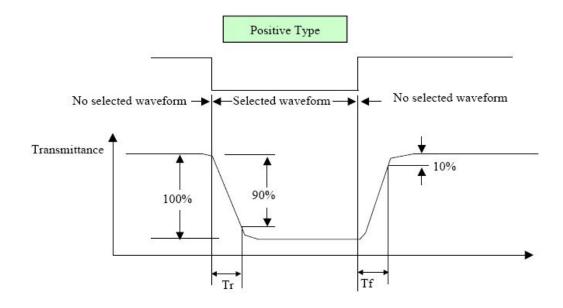
Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Response tim	ne	Tr+Tf		_	45	80	ms	
Contrast ratio)	CR		_	350	_	_	
Transmittance	е	T%		_	15.73	_	%	
	White	Wx		0.285	0.305	0.325	_	
	vviile	Wy		0.310	0.330	0.350	_	
	Red	Rx	$\theta x = \theta y = 0$	0.605	0.625	0.645		
Color		Ry		0.305	0.325	0.345		
chromaticity	Green	Gx		0.272	0.292	0.312	_	Referen
		Gy		0.555	0.575	0.595	_	ce only
	Dive	Bx		0.113	0.133	0.153	_	
	Blue	Ву		0.114	0.134	0.154	_	
	Hor.	θ x+		_	45	_	0	
Viewing angle	ПОГ.	θx-	_	_	45	_		
		θу+	CR ≥ 10	_	35	_		
	Ver.	θу-		_	15	_	, o	

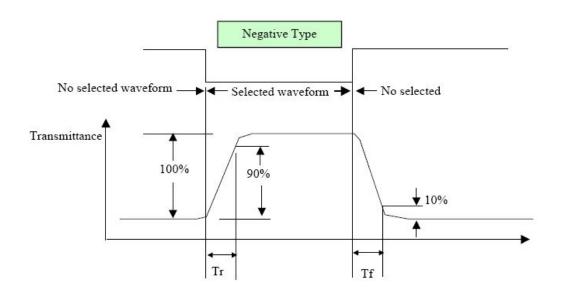
5.1 Definition of Viewing Angle



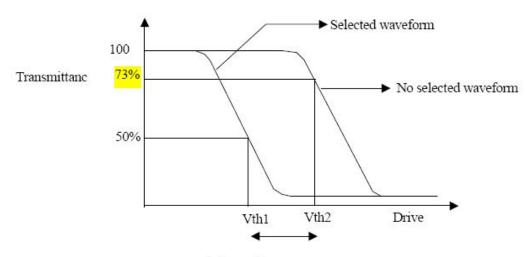
Viewing angle

5.2 Definition of Response Time





5.3 Definition of V_{th}



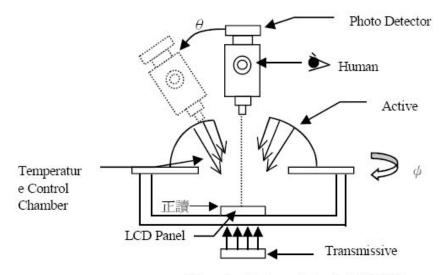
Active voltage range

	Vth1	Vth2
View direction	10 °	40 °
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System

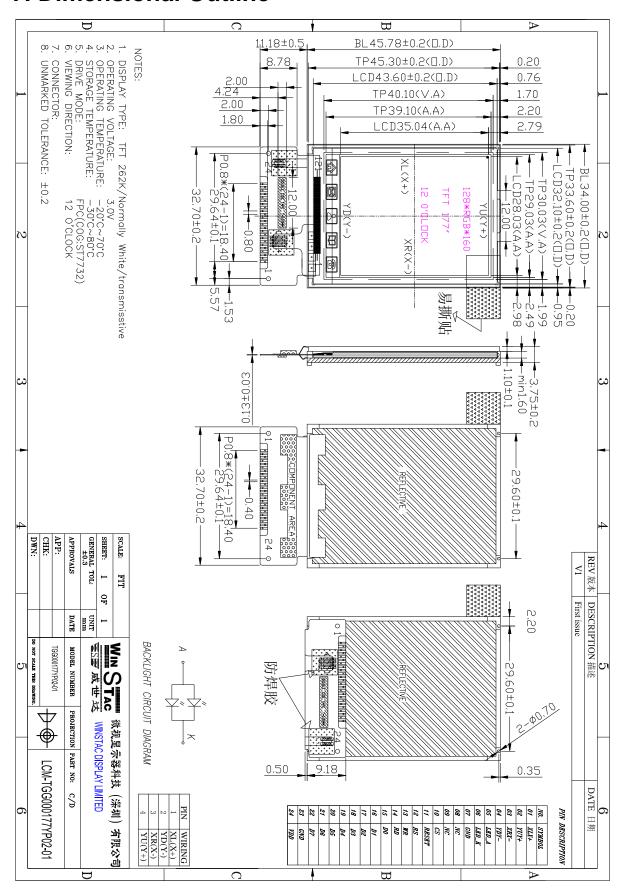


Measuring System: Autronic DMS-803

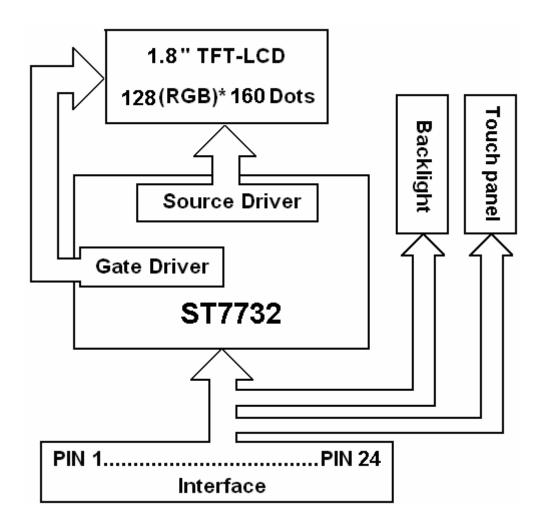
6. Touch screen characteristics

Item	Specification
Input Method	ABS Pen
ITO Glass	T=0.7mm , $400\Omega/\Box$
ITO Film	T=0.18mm , $400 \Omega/\Box$
Surface Hardness	铅笔硬度 2H 以上
Insulation Impedance	DC7.5V,20MΩ 以上
Light Transparency	80% min.
Linearity	≤ 1.5%
Physics Resume	<15ms
Operation Pressure	30~150g
MAX Pressure	1000gf
Operation Voltage.	5V DC. Max Voltage: 7V DC.

7. Dimensional Outline



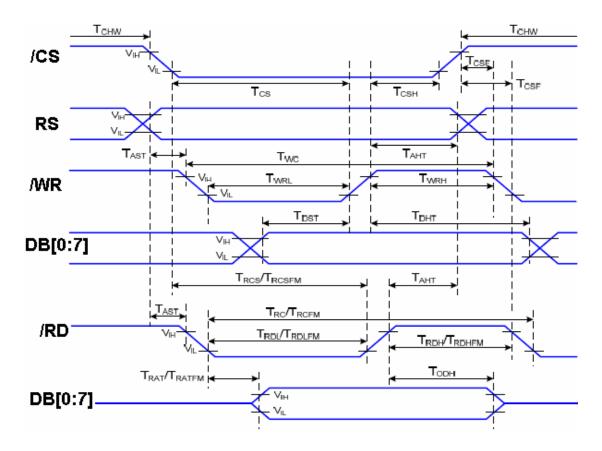
- 8. Module Function Description
- 8.1 Block Diagram.



8.2 Pin Description

No.	SYMBOL	FUNCITION
1	XL(X+)	
2	YU(Y+)	Touch screen output terminals, if no touch screen is
3	XR(X-)	used, left these pins open or fix them to GND level.
4	YD(Y-)	
5	LEDA	Power supply for backlight anode input terminal.
6	LEDK	Power supply for backlight cathode input terminal.
7	GND	Power ground.
8	NC	Not connected, left open.
9	NC	Not connected, left open.
		Chip select signal input terminal:
10	/CS	/CS='H': The LCM is selected and accessible;
		/CS='L': The LCM is not selected and not accessible.
11	/RESET	Reset signal input terminal. Active at 'L'.
		Display data/Command select signal input terminal:
12	RS	RS='L': current data on data bus is a command;
		RS='H': current data on data bus is display data.
13	/WR	Write control signal input, active at 'L'.
14	/RD	Read control signal input, active at 'L'.
15	DB0	
16	DB1	
17	DB2	
18	DB3	8-bit bi-direction data bus.
19	DB4	ชามเ มา-นแองแบบ นสเส มนร.
20	DB5	
21	DB6	
22	DB7	
23	GND	Power ground.
24	VDD	System power supply terminal. (VDD>VSS)

8.3 Timing Characteristics



VDD=2.8V, Ta=25°C

Signal	Symbol	Parameter	Min	Max	Unit	Description		
RS	T _{AST}	Address setup time	5		ns			
N3	T _{AHT}	Address hold time (Write/Read)	10		ns	-		
	T _{CHW}	Chip select "H" pulse width	0		ns			
	Tcs	Chip select setup time (Write)	20		ns	-(3-transfer for one pixel)		
ıcs	T _{RCS}	Chip select setup time (Read ID)	20		ns			
,03	T _{RCSFM}	Chip select setup time (Read FM)	20		ns	-(3-transfer for one pixer)		
	Tose	Chip select wait time (Write/Read)	10		ns			
	T _{CSH}	Chip select hold time	20		ns			
	Twc	Write cycle	66		ns			
/WR	Twrh	Control pulse "H" duration	25		ns			
	T _{WRL}	Control pulse "L" duration	15		ns			
	T _{RC}	Read cycle (ID)	160		ns			
/RD(ID)	T _{RDH}	Control pulse "H" duration (ID)	90		ns	When read ID data		
	T _{RDL}	Control pulse "L" duration (ID)	45		ns			
	T _{RCFM}	Read cycle (FM)	160		ns	When read from frame		
□/RD(FM)	T _{RDHFM}	Control pulse "H" duration (FM)	90		ns	memory		
	T _{RDLFM}	Control pulse "L" duration (FM)	45		ns	memory		
	T _{DST}	Data setup time	15		ns	For maximum CL=30pF		
DB[0:7]	T _{DHT}	Data hold time	15		ns	For minimum CL=8pF		
	T _{ODH}	Output disable time	20	80	ns	1 of Hillimidal CL-ope		

9. Reliability Testing

No.	Test Item	Test condition	Criterion
1	High Temperature Storage	80°C±2°C96H Restore 4H at 25°C	
2	Low Temperature Storage	-30°C±2°C 96H Restore 4H at 25°C	
3	High Temperature Operation	70°C±2°C 48H Restore 4H at 25°C	
4	Low Temperature Operation	-20°C±2°C 48H Restore 4H at 25°C	After testing, cosmetic defects should not happen.
5	High Temperature /Humidity Storage	40℃±2℃ 90%RH 48H	2. Total current consumption should not be over 10% of
6	Temperature Cycle	-30°C ← 25°C ← 80°C 5min 30min ← 25°C, 5min after 10cycle, Restore 4H at 25°C	initial value.
7	Vibration Test (package state)	10Hz~150Hz, 100m/s2, 120min	
8	Shock Test (package state)	Half- sine wave, 300m/s2, 18ms	Not allowed cosmetic and electrical defects.
9	Atmospheric Pressure Test	25kPa 16H Restore 2H	
10	Cable Bending Test	Bending area and angle follow design document requirement	More than 50000 times

10. Quality Specification

	Note					
General	 Should any defects which are not specified in this standard happen, additional standard shall be determined by mutual agreement between customer and Tianma. Viewing Area should be the area which Tianma guarantees. Limited sample should be prior to this Inspection standard. Viewing Judgement should be under static pattern. Inspection conditions Inspection distance 250 mm (from the sample) Temperature 25±5°C Inspection angle 45degrees in LCD view direction 					
Definitions of	Pinhole, Bright spot,					
Inspection	Black spot, White spot,	remainder.	904 W			
items	Black line, White Line, Foreign particle, Bubble	The phenomenon dose not change with voltage.				
	Contrast variation	different from the tage.				
	Polarizer defect	Scratch, Dirt, Particle, Bubble on polarizer or between polarizer and glass.				
	Glass defect	lass defect Glass crack, Shaved corner of glass,				
Definitions of Inspection ranges	X1	X1 X2 Dividing A zone and B zone proceed to make a judgment. Y2 A zone: Inside Viewing area B zone: Outside Viewing area X1(A.A~V.A): mm X2(A.A~V.A): mm Y1(A.A~V.A): mm Y2(A.A~V.A): mm				
Outgoing	Inspection level II Nor	mal Inspection Sampling standard co	nforms to GB2828			
Inspection standard	Rank Inspection Item	ı	AQL(Number of defective LCMs counted)			
	Major All Functional defect abnormally, O circuit, Missi abnormally),Ou drawing	0.65				
	Minor Appearance de defect Bright spot, P variation, Bubb	Minor Appearance defects, such as Black/White spot,				

			Judgement standard					
Inspection item			7-27			Acceptable number		
			Category		A	zone	B zone	
1	Black spot, White spot Bright Spot, Pinhole Foreign P Bubble and Particle Between polarizer Scratch on polariz	$\Phi = (a+b)/2 \text{(mm)}$ and glass,	A B C D	$\Phi \le 0.15$ $0.15 < \Phi \le 0.20$ $0.20 < \Phi \le 0.30$ $0.30 < \Phi$ Total defective point(B,C)	Neg	glecte 2 1 0 3	Neglected	
2	Black line, White line, Bubble and Particle Between Polarizer and glass, Scratch on polarizer	W:Width, L:Length(mm)	A B C D	$W \le 0.10$ $0.01 < W \le 0.03$ $L \le 3.0$ $0.03 < W \le 0.05$ $L \le 3.0$ 0.05 < W Total defective point(B,C)	Neg	lected 2 1 0	Neglected	
3	Contrast variation	$ \begin{array}{c} $	A B C D	$\Phi \le 0.2$ $0.2 < \Phi \le 0.3$ $0.3 < \Phi \le 0.4$ $0.4 < \Phi$ Total defective point(B,C)	Neg	2 1 0 3	Neglected	
4	Bubble inside cell		any size		n	one	none	
5	Polarizer defect (if Polarizer is used)	Scratch and damage on polarizer, Particle on polarizer or between polarizer and glass. Bubble, dent and convex	Refer to item 1 and item 2. A $\Phi \le 0.3$ B $0.3 < \Phi \le 0.7$ C $0.7 < \Phi$ Total defective point(B,C)			elected	Neglected	
6	Surplus glass	①Stage surplus glass b ②Surrounding surplus glass		0.3mm uld not influence outline dime	nsion	and as	sembling.	

Inspection item				Judgment standard			
		and the control of the second state of the second state of the second se		Category(application: B zone)			
7	Glass defect crack	ect		If $a \le t$ and $b \le 1.0$, c is not limited $a \le t, 1 \le b \le 2mm, c \le 3mm$ If glass crack cover alignment mark, $b \le 0.5mm$.			
		w t	D	Crack at two sids of lead terminals should not cover patterns and alignment mark			
		②Surrounding crack—non-contact side seal c b a t c b a Inner border line of the seal Outer border line of the seal	b < Inner borderline of the seal				
		Surrounding crack— contact side seal t Inner border line of the seal Outer border line of the seal	1	b < Outer borderline of the seal			
		4 Corner W C	A *G for	$a \le t$, $b \le 3.0$, $c \le 3.0$ class crack should not cover patterns used			

11. Precautions for Using LCD Module

11.1 Handing Precautions

- (1) The display panel is made of glass. Do not subject it to a mechanical shock or impact by dropping it.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten a cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol
- (6) Solvents other than those above mentioned may damage the polarizer. Especially, do not use the following:
 - Water
 - Ketone
 - -The LCD Module is coated with Aromatic solvents
- (7) Extra care to minimize corrosion of the electrode. Water droplets, moisture condensation or a current flow in a high-humidity environment accelerates corrosion of the electrode.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD Module, make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD Module.
- (10) NC terminal should be open. Do not connect anything.
- (11) If the logic circuit power is off, do not apply the input signals.
- (12) To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling he LCD Module.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct

assembling and other work under dry conditions.

-The LCD Module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

11.2 Precaution For Soldering To The LCM

Observe the following when soldering lead wire, connector cable and etc. to the LCM.

- -Soldering iron temperature: 280 ±10°C.
- -Soldering time: 3-4 sec.
- -Solder: eutectic solder.

If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering the prevent any damage due to flux spatters.

When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

When removing the electroluminescent panel from the PC board, be sure the solder has completely melted, otherwise the soldered pad on the PC board could be damaged.

11.3 Precaution For Operation

- (1) Viewing angle varies with the change of liquid crystal driving voltage (Vo). Adjust Vo to show the best contrast.
- (2) Driving the LCD in the voltage above the limit will shorten its lifetime.
- (3) Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- (4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then on.
- (5) Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C, 50% RH.
- (6) When turning the power on, input each signal after the positive/negative voltage becomes stable.

11.4 Precaution For Storage

When storing LCDS as spares for some years, the following precaution are necessary.

Store them in a sealed polyethylene bag. If properly scaled, there is no need for desiccant.

Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.

The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.) Environmental conditions:

- -Do not leave them for more than 168hrs. at 60 °C.
- -Should not be left for more than 48hrs. at -20 °C.

11.5 Safety

It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

11.6 Limited Warranty

Unless agreed between Matrix and customer, Matrix will replace or repair any of its LCD and modules which are found to be functionally defective when inspected in accordance with Matrix LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to Matrix within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of Matrix is limited to repair and/or replacement on the terms set forth above. Matrix will not be responsible for any subsequent or consequential events.